

• General Description

The AGM13T30A combines advanced trench MOSFET technology with a low resistance package to provide extremely low R_{DS(ON)}.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

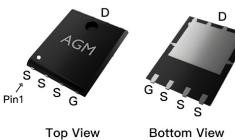
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

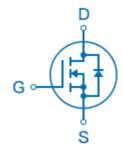
Product Summary

BVDSS	RDSON	ID
135V	32.5mΩ	30A

PDFN5*6 Pin Configuration







Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM13T30A	AGM13T30A	PDFN5*6	330mm	12mm	3000

Absolute Maximum Ratings (TA=25℃) Table 1.

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	135	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	30	Α
_	Drain Current-Continuous(Tc=100℃)	20	Α
IDM (pluse)	Drain Current-Pulsed (Note 2)	120	Α
PD	Maximum Power Dissipation(Tc=25℃)	120	W
	Maximum Power Dissipation(Tc=100℃)	60	w
EAS	Avalanche energy (Note 3)	21	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 175	$^{\circ}\!\mathbb{C}$

Table 2. **Thermal Characteristic**

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		20	°C/W
RθJC	Thermal Resistance Junction-Case ¹		1.25	°C/W



Table 3. Electrical Characteristics (TJ=25^oC unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	ites					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	135	147		V
IDSS	Zero Gate Voltage Drain Current	VDS=135V,VGS=0V			1	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2	2.8	4	V
gFS	Forward Transconductance	VDS=5V,ID=5A		11		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=10A		32.5	38	mΩ
Dynamic C	Characteristics					
Ciss	Input Capacitance	VDS=40V,VGS=0V,		622		pF
Coss	Output Capacitance	F=1MHZ		251		pF
Crss	Reverse Transfer Capacitance			11		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		2.6		Ω
Switching	Times					
td(on)	Turn-on Delay Time			10	-	nS
tr	Turn-on Rise Time	VGS=10V,VDS=75V,		6.5	1	nS
td(off)	Turn-Off Delay Time	RGEN=3 Ω , RL=7.5 Ω		16		nS
tf	Turn-Off Fall Time			7.0	-	nS
Qg	Total Gate Charge			33		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=75V, ID=20A		7.2		nC
Qgd	Gate-Drain Charge	- ID-207(7.2		nC
Source-Dr	ain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				30	А
VSD	Forward on Voltage	VGS=0V,IS=20A			1.2	V
trr	Reverse Recovery Time	IF=20A , dI/dt=100A/μs ,		30		ns
Qrr	Reverse Recovery Charge	TJ=25℃		135		nc

Notes 1. The maximum current rating is package limited.

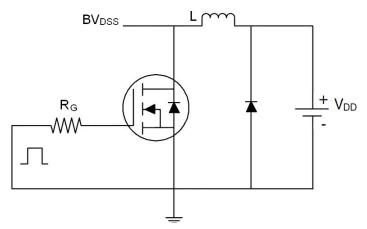
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}\text{C}$,VDD=50V,Vgs=10V,L=0.1mH,RG=25ohm

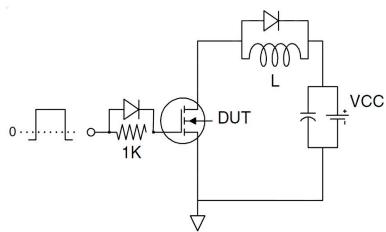


Test Circuit

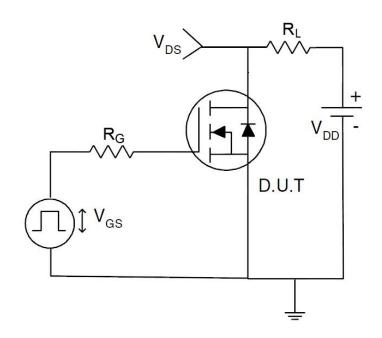
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

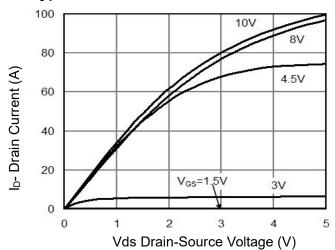


Figure 1 Output Characteristics

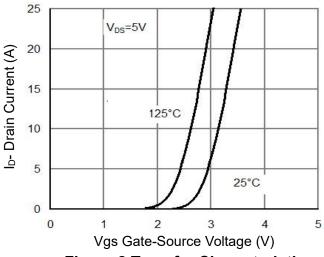


Figure 2 Transfer Characteristics

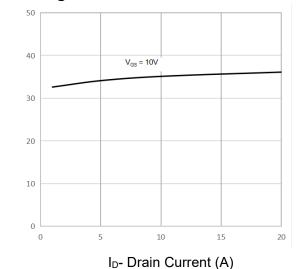


Figure 3 Rdson- Drain Current

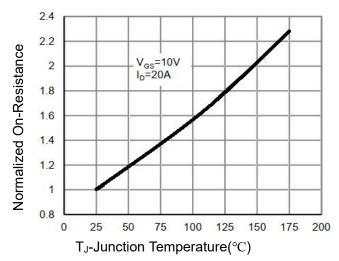


Figure 4 Rdson-Junction Temperature

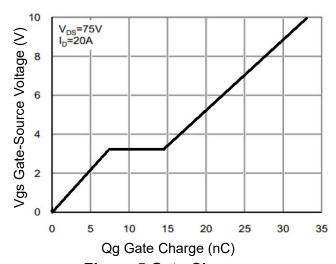


Figure 5 Gate Charge

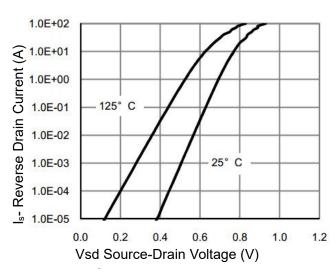


Figure 6 Source- Drain Diode Forward



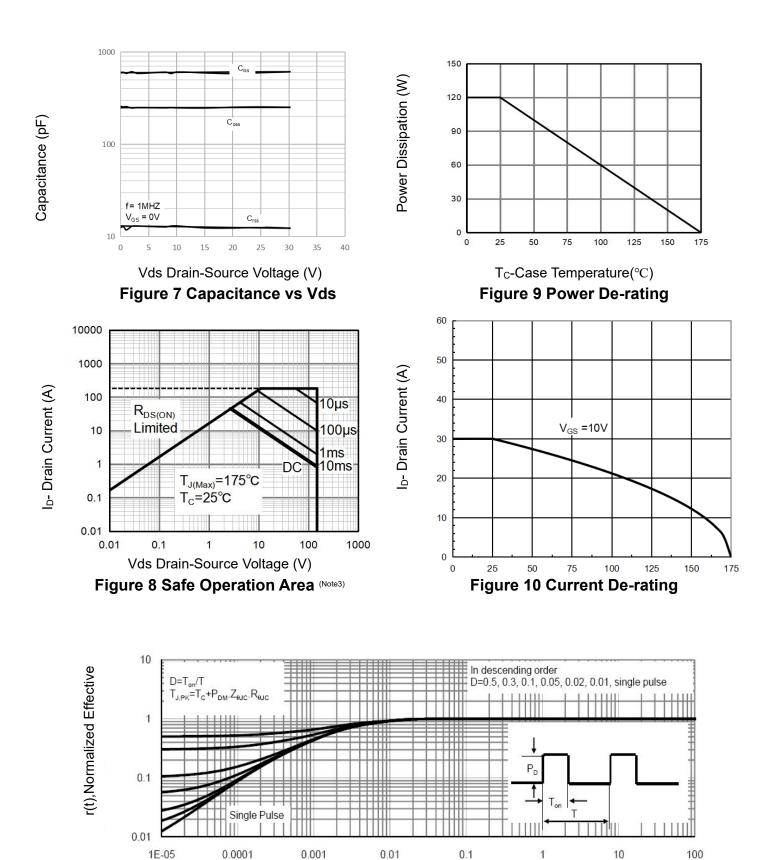
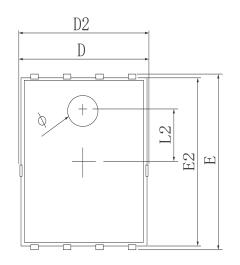


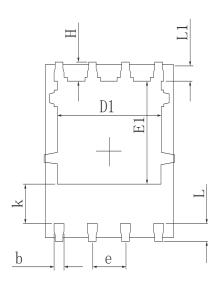
Figure 11 Normalized Maximum Transient Thermal Impedance

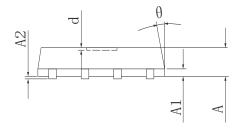
Square Wave Pluse Duration(sec)



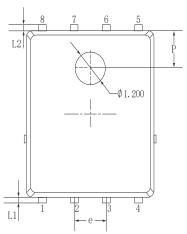
•Dimensions (PDFN5*6)

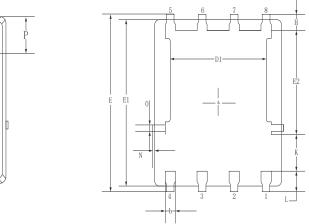






ounmor.	MILLIMETER			
SYMBOL	MIN	Тур.	MAX	
A	0.900	1.000	1.100	
A1	0.254 REF.			
A2		0~0.05		
D	4. 824	4.900	4.976	
D1	3.910	4.010	4.110	
D2	4. 924	5.000	5. 076	
Е	5. 924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5. 674	5. 750	5. 826	
b	0.350	0.400	0.450	
е	1.270 TYP.			
L	0.534	0.610	0.686	
L1	0.424	0.500	0.576	
L2	1.800 REF.			
k	1.190	1.290	1.390	
Н	0. 549	0.625	0.701	
θ	8°	10°	12°	
Ф	1.100	1.200	1.300	
d			0.100	





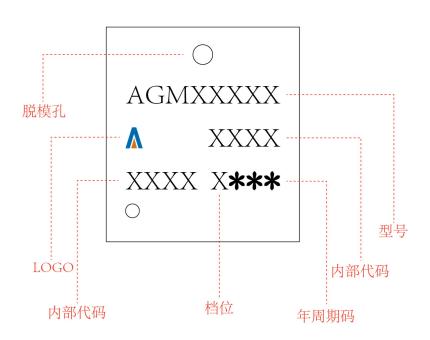
M	θ
	A
C	
D—————————————————————————————————————	

	Millimeters			
Symbol	MIN.	NOM.	MAX.	
A	0.90	1.05	1. 20	
b	0.35	0.40	0.50	
С	0.20	0. 25	0.35	
D	4.90	5.05	5. 20	
D1	3.72	3. 82	3. 92	
E	6.00	6.15	6.30	
E1	5.60	5. 75	5. 90	
E2	3. 47	3. 57	3. 67	
е	1. 27 BSC.			
Н	0.48	0.58	0.68	
K	1.17	1. 27	1. 37	
L	0.64	0.74	0.84	
L1/L2	0.20 REF.			
θ	8°	10°	12°	
M	0.08 REF.			
N	0	-	0.15	
0	0. 25 REF.			
P		1.28 REF.		

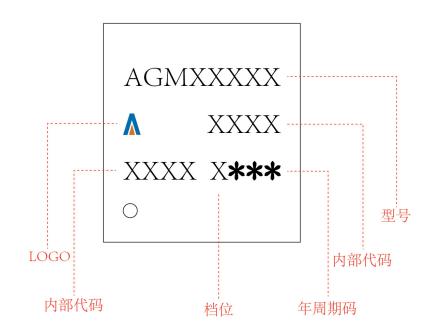


PDFN5*6 Marking Instructions:

Model1:



Model2:





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